LDO Linear Regulators -Micropower, ENABLE, DELAY, RESET, Monitor FLAG

150 mA

The NCV8501 is a family of precision micropower voltage regulators. Their output current capability is 150 mA. The family has output voltage options for adjustable, 2.5 V, 3.3 V, 5.0 V, 8.0 V, and 10 V.

The output voltage is accurate within $\pm 2.0\%$ with a maximum dropout voltage of 0.6 V at 150 mA. Low quiescent current is a feature drawing only 90 μ A with a 100 μ A load. This part is ideal for any and all battery operated microprocessor equipment.

Microprocessor control logic includes an active $\overline{\text{RESET}}$ (with DELAY), and a FLAG monitor which can be used to provide an early warning signal to the microprocessor of a potential impending $\overline{\text{RESET}}$ signal. The use of the FLAG monitor allows the microprocessor to finish any signal processing before the $\overline{\text{RESET}}$ shuts the microprocessor down.

The active $\overline{\text{RESET}}$ circuit operates correctly at an output voltage as low as 1.0 V. The $\overline{\text{RESET}}$ function is activated during the power up sequence or during normal operation if the output voltage drops outside the regulation limits.

The regulator is protected against reverse battery, short circuit, and thermal overload conditions. The device can withstand load dump transients making it suitable for use in automotive environments. The device has also been optimized for EMC conditions.

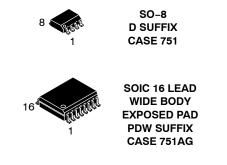
Features

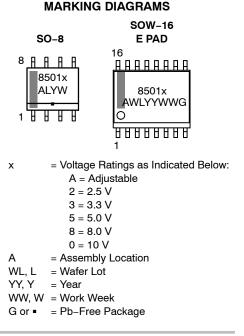
- Output Voltage Options: Adjustable, 2.5 V, 3.3 V, 5.0 V, 8.0 V, 10 V
- ±2.0% Output
- Low 90 µA Quiescent Current
- Fixed or Adjustable Output Voltage
- Active **RESET**
- ENABLE
- 150 mA Output Current Capability
- Fault Protection
 - ♦ +60 V Peak Transient Voltage
 - → -15 V Reverse Voltage
 - Short Circuit
 - Thermal Overload
- Early Warning through FLAG/MON Leads
- NCV Prefix for Automotive and Other Applications Requiring Site and Change Control
- These are Pb-Free Devices



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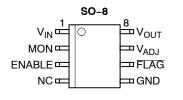




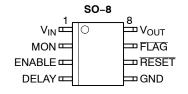
ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 14 of this data sheet.

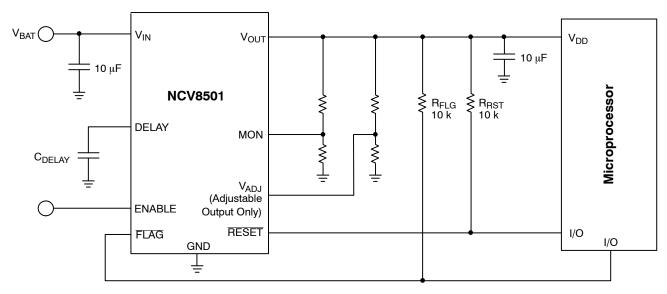
PIN CONNECTIONS, ADJUSTABLE OUTPUT



PIN CONNECTIONS, FIXED OUTPUT



SOW-16 E PAD					
1 r		16			
FLAG 📼		RESET			
V _{OUT} ाा		⊐ NC			
NC 📼		⊐ NC			
NC 📼		🖿 GND			
NC 📼		⊐ NC			
NC 📼		III NC			
V _{IN} ⊏		DELAY			
момщ		III ENABLE			





MAXIMUM RATINGS*

Rating	Value	Unit
V _{IN} (dc)	-15 to 45	V
Peak Transient Voltage (46 V Load Dump @ V _{IN} = 14 V)	60	V
Operating Voltage	45	V
V _{OUT} (dc)	–0.3 to 16	V
Voltage Range (RESET, FLAG)	–0.3 to 10	V
Input Voltage Range (MON) (VAOJ)	–0.3 to 10 –0.3 to 16	V
Input Voltage Range (ENABLE)	–0.3 to 10**	V
ESD Susceptibility (Human Body Model)	2.0	kV
Junction Temperature, T _J	-40 to +150	°C
Storage Temperature, T _S	-55 to 150	°C
Package Thermal Resistance, SO-8: Junction-to-Case, R _{0JC} Junction-to-Ambient, R _{0JA}	45 165	°C/W °C/W
Package Thermal Resistance, SOW-16 E PAD: Junction-to-Case, R _{0JC} Junction-to-Ambient, R _{0JA} Junction-to-Pin, R _{0JP} (Note 1)	15 56 35	°C/W °C/W °C/W
Lead Temperature Soldering: Reflow: (SMD styles only) (Note	2) 260 Peak (Note 3)	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

*During the voltage range which exceeds the maximum tested voltage of VIN, operation is assured, but not specified. Wider limits may apply. Thermal dissipation must be observed closely. **Reference Figure 15 for switched-battery ENABLE application.

1. Measured to pin 16.

2. 150 second maximum above 217°C.

3. $-5^{\circ}C / +0^{\circ}C$ allowable conditions.

ELECTRICAL CHARACTERISTICS (I_{OUT} = 1.0 mA, ENABLE = 5.0 V, $-40^{\circ}C \le T_J \le 150^{\circ}C$; V_{IN} dependent on voltage option (Note 4); unless otherwise specified.)

Characteristic	Test Conditions	Min	Тур	Max	Unit
Dutput Stage					
Output Voltage for 2.5 V Option	6.5 V < V _{IN} < 16 V, 100 μ A \leq I _{OUT} \leq 150 mA 5.5 V < V_{IN} < 26 V , 100 μ A \leq I _{OUT} \leq 150 mA	2.450 2.425	2.5 2.5	2.550 2.575	V V
$ \begin{array}{llllllllllllllllllllllllllllllllllll$		3.234 3.201	3.3 3.3	3.366 3.399	V V
Output Voltage for 5.0 V Option	9.0 V < V _{IN} < 16 V, 100 μ A ≤ I _{OUT} ≤ 150 mA 6.0 V < V _{IN} < 26 V, 100 μ A ≤ I _{OUT} ≤ 150 mA	4.90 4.85	5.0 5.0	5.10 5.15	V V
Output Voltage for 8.0 V Option	9.0 V < V_{IN} < 26 V , 100 μA ≤ I _{OUT} ≤ 150 mA	7.76	8.0	8.24	V
Output Voltage for 10 V Option	11 V < V_{IN} < 26 V , 100 μA ≤ I _{OUT} ≤ 150 mA	9.7	10	10.3	V
Output Voltage for Adjustable Option Dropout Voltage (V _{IN} – V _{OUT})	$\begin{split} &V_{OUT} = V_{ADJ} \text{ (Unity Gain)} \\ &6.5 \text{ V} < V_{\text{IN}} < 16 \text{ V}, 100 \ \mu\text{A} < I_{OUT} < 150 \text{ mA} \\ &5.5 \text{ V} < V_{\text{IN}} < 26 \text{ V}, 100 \ \mu\text{A} < I_{OUT} < 150 \text{ mA} \\ &I_{OUT} = 150 \text{ mA} \end{split}$	1.254 1.242 -	1.280 1.280 400	1.306 1.318 600	V V mV
(5.0 V, 8.0 V, 10 V, and Adj. > 5.0 V Options Only)	l _{OUT} = 1.0 mA	-	100	150	mV
Load Regulation	V_{IN} = 14 V, 5.0 mA $\leq I_{OUT} \leq$ 150 mA	-30	5.0	30	m۷
Line Regulation	$[V_{OUT}(Typ) + 1.0] < V_{IN} < 26 \text{ V}, I_{OUT} = 1.0 \text{ mA}$	-	15	60	m۷
Quiescent Current, Low Load 2.5 V Option 3.3 V Option 5.0 V Option 8.0 V Option 10 V Option Adjustable Option	I _{OUT} = 100 μA, V _{IN} = 12 V, MON = V _{OUT}		90 90 90 100 100 50	125 125 125 150 150 75	μΑ μΑ μΑ μΑ μΑ
Quiescent Current, Medium Load $I_{OUT} = 75 \text{ mA}, V_{IN} = 14 \text{ V}, \text{ MON} = V_{OUT}$ All Options		-	4.0	6.0	mA
Quiescent Current, High Load All Options	I_{OUT} = 150 mA, V_{IN} = 14 V, MON = V_{OUT}	I	12	19	mA
Quiescent Current, (I _Q) Sleep Mode	ENABLE = 0 V, V _{IN} = 12 V	-	12	30	μA
Current Limit	_	151	300	-	mA
Short Circuit Output Current	V _{OUT} = 0 V	40	190		mA
Thermal Shutdown	(Guaranteed by Design)	150	180	-	°C
Reset Function (RESET)					
RESET Threshold for 2.5 V Option HIGH (V _{RH}) LOW (V _{RL})	5.5 V \leq V _{IN} \leq 26 V (Note 5) V _{OUT} Increasing V _{OUT} Decreasing	2.28 2.25	2.350 2.300	$\begin{array}{c} 0.98 \times V_{OUT} \\ 0.97 \times V_{OUT} \end{array}$	v v
RESET Threshold for 3.3 V Option HIGH (V _{RH})	5.5 V \leq V _{IN} \leq 26 V (Note 5) V _{OUT} Increasing	3.00	3.102	$0.98 imes V_{OUT}$	v

HIGH (V _{RH}) LOW (V _{RL})	V _{OUT} Increasing V _{OUT} Decreasing	3.00 2.97	3.102 3.036	$\begin{array}{l} 0.98 \times V_{OUT} \\ 0.97 \times V_{OUT} \end{array}$	V V
RESET Threshold for 5.0 V Option HIGH (V _{RH}) LOW (V _{RL})	V _{OUT} Increasing V _{OUT} Decreasing	4.55 4.50	4.70 4.60	0.98 × V _{OUT} 0.97 × V _{OUT}	V V
RESET Threshold for 8.0 V Option HIGH (V _{RH}) LOW (V _{RL})	V _{OUT} Increasing V _{OUT} Decreasing	7.05 7.00	7.52 7.36	0.98 × V _{OUT} 0.97 × V _{OUT}	< <

4. Voltage range specified in the Output Stage of the Electrical Characteristics in boldface type. 5. For $V_{IN} \le 5.5$ V, a RESET = Low may occur with the output in regulation.

ELECTRICAL CHARACTERISTICS (I_{OUT} = 1.0 mA, ENABLE = 5.0 V, $-40^{\circ}C \le T_J \le 150^{\circ}C$; V_{IN} dependent on voltage option (Note 4); unless otherwise specified.)

Characteristic	Test Conditions	Min	Тур	Мах	Unit
Reset Function (RESET)					
RESET Threshold for 10 V Option HIGH (V _{RH}) LOW (V _{RL})	V _{OUT} Increasing V _{OUT} Decreasing	8.60 8.50	9.40 9.20	$0.98 imes V_{OUT}$ $0.97 imes V_{OUT}$	V V
Output Voltage Low (V _{RLO})	$1.0 \text{ V} \le \text{V}_{OUT} \le \text{V}_{RL}, \text{ R}_{\overline{\text{RESET}}} = 10 \text{ k}$	_	0.1	0.4	V
DELAY Switching Threshold (V _{DT})	-	1.4	1.8	2.2	V
DELAY Low Voltage	V _{OUT} < RESET Threshold Low(min)	-	-	0.1	V
DELAY Charge Current	DELAY = 1.0 V, V _{OUT} > V _{RH}	1.5	2.5	3.5	μA
DELAY Discharge Current	DELAY = 1.0 V, V _{OUT} = 1.5 V	5.0	-	-	mA
FLAG/Monitor					
Monitor Threshold	Increasing and Decreasing	1.10	1.20	1.31	V
Hysteresis	-	20	50	100	mV
Input Current	MON = 2.0 V	-0.5	0.1	0.5	μA
Output Saturation Voltage	MON = 0 V, I _{FLAG} = 1.0 mA	-	0.1	0.4	V
Voltage Adjust (Adjustable Output o	only)				
Input Current	V _{ADJ} = 1.28 V	-0.5	-	0.5	μA
ENABLE					
Input Threshold	Low High	_ 3.0	-	0.5	V V
Input Current ENABLE = 5.0 V		-	1.0	5.0	μA

4. Voltage range specified in the Output Stage of the Electrical Characteristics in boldface type. 5. For $V_{IN} \le 5.5$ V, a RESET = Low may occur with the output in regulation.

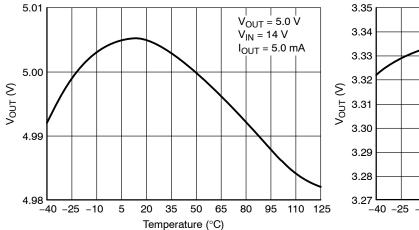
PACKAGE PIN DESCRIPTION, ADJUSTABLE OUTPUT

Package	Pin Number		
SOW-16 SO-8 E PAD		Pin Symbol	Function
1	7	V _{IN}	Input Voltage.
2	8	MON	Monitor. Input for early warning comparator. If not needed connect to VOUT.
3	9	ENABLE	ENABLE control for the IC. A high powers the device up.
4	3–6, 10–12, 14, 15	NC	No connection.
5	13	GND	Ground. All GND leads must be connected to Ground
6	16	FLAG	Open collector output from early warning comparator.
7	1	V _{ADJ}	Voltage Adjust. A resistor divider from V _{OUT} to this lead sets the output voltage.
8	2	V _{OUT}	±2.0%, 150 mA output.

PACKAGE PIN DESCRIPTION, FIXED OUTPUT

Package F	Package Pin Number			
SOW-16 SO-8 E PAD Pin S		Pin Symbol	Function	
1	7	V _{IN}	Input Voltage.	
2	8	MON	Monitor. Input for early warning comparator. If not needed connect to $V_{\mbox{OUT.}}$	
3	9	ENABLE	ENABLE control for the IC. A high powers the device up.	
4	10	DELAY	Timing capacitor for RESET function.	
5	13	GND	Ground. All GND leads must be connected to Ground	
6	16	RESET	Active reset (accurate to $V_{OUT} \ge 1.0 \text{ V}$)	
7	1	FLAG	Open collector output from early warning comparator.	
8	2	V _{OUT}	±2.0%, 150 mA output.	
_	3–6, 11, 12, 14, 15	NC	No connection.	

TYPICAL PERFORMANCE CHARACTERISTICS





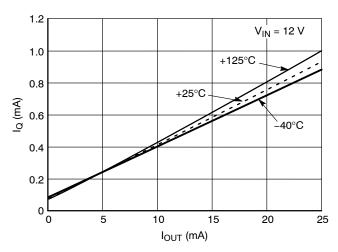


Figure 4. Quiescent Current vs. Output Current

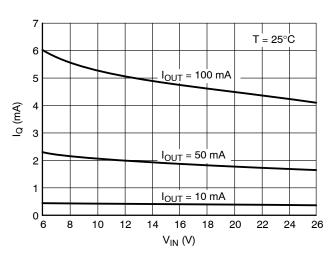
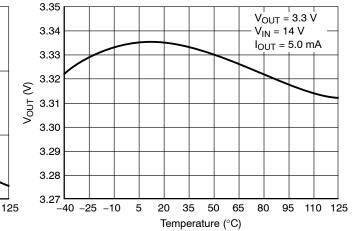


Figure 6. Quiescent Current vs. Input Voltage





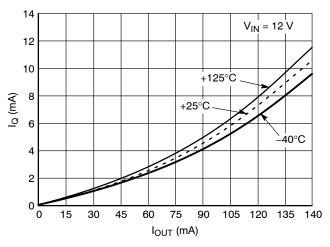
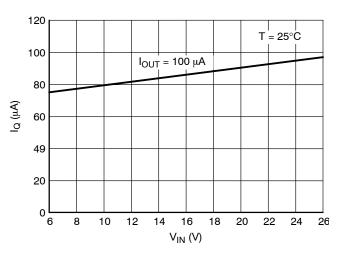
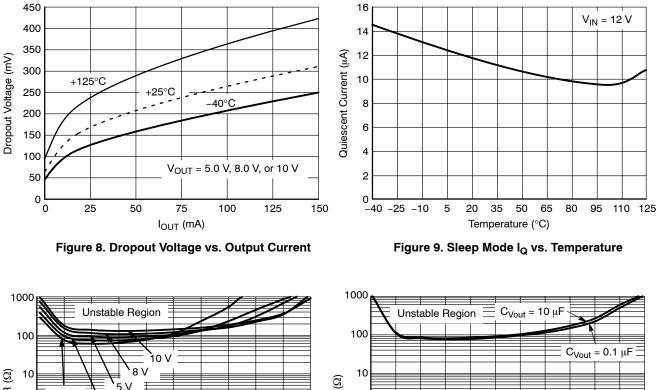


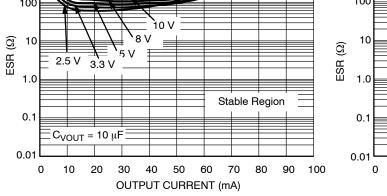
Figure 5. Quiescent Current vs. Output Current

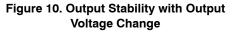


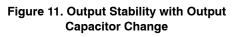


TYPICAL PERFORMANCE CHARACTERISTICS









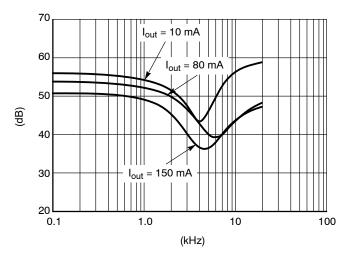
50 60 70 80

OUTPUT CURRENT (mA)

10 20 30 40

Stable Region

90 100 110





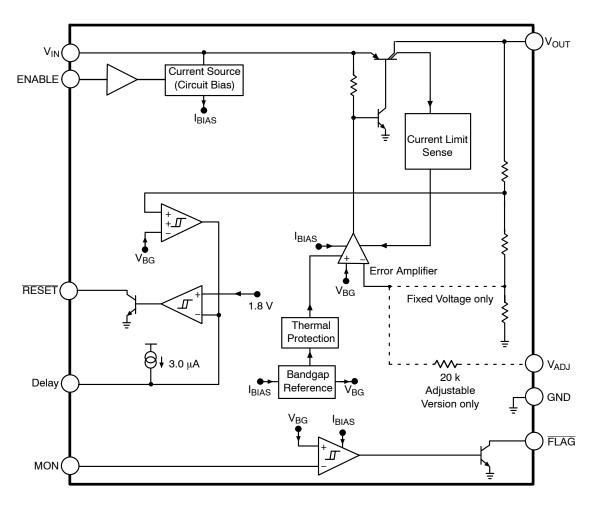


Figure 13. Block Diagram

CIRCUIT DESCRIPTION

REGULATOR CONTROL FUNCTIONS

The NCV8501 contains the microprocessor compatible control function $\overline{\text{RESET}}$ (Figure 14).

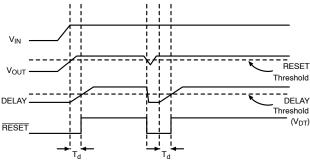


Figure 14. Reset and Delay Circuit Wave Forms

RESET Function

A RESET signal (low voltage) is generated as the IC powers up until V_{OUT} is within 6.0% of the regulated output voltage, or when V_{OUT} drops out of regulation, and is lower than 8.0% below the regulated output voltage. Hysteresis is included in the function to minimize oscillations.

The RESET output is an open collector NPN transistor, controlled by a low voltage detection circuit. The circuit is functionally independent of the rest of the IC thereby guaranteeing that the RESET signal is valid for V_{OUT} as low as 1.0 V.

ENABLE Function

The part stays in a low I_Q sleep mode when the ENABLE pin is held low. The part has an internal pull down if the pin is left floating. This is intended for failure modes only. An external connection (active pulldown, resistor, or switch) for normal operation is recommended.

The integrity of the ENABLE pin allows it to be tied directly to the battery line through an external resistor. It will withstand load dump potentials in this configuration.

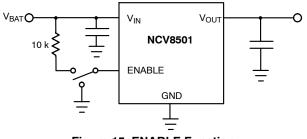


Figure 15. ENABLE Function

DELAY Function

The reset delay circuit provides a programmable (by external capacitor) delay on the $\overline{\text{RESET}}$ output lead.

The DELAY lead provides source current (typically 2.5 μ A) to the external DELAY capacitor during the following proceedings:

- 1. During Power Up (once the regulation threshold has been verified).
- 2. After a reset event has occurred and the device is back in regulation. The DELAY capacitor is discharged when the regulation (RESET threshold) has been violated. This is a latched incident. The capacitor will fully discharge and wait for the device to regulate before going through the delay time event again.

FLAG/Monitor Function

An on-chip comparator is provided to perform an early warning to the microprocessor of a possible reset signal. The reset signal typically turns the microprocessor off instantaneously. This can cause unpredictable results with the microprocessor. The signal received from the FLAG pin will allow the microprocessor time to complete its present task before shutting down. This function is performed by a comparator referenced to the bandgap reference. The actual trip point can be programmed externally using a resistor divider to the input monitor (MON) (Figure 16). The typical threshold is 1.20 V on the MON pin.

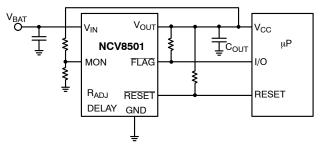


Figure 16. FLAG/Monitor Function

Voltage Adjust

Figure 17 shows the device setup for a user configurable output voltage. The feedback to the V_{ADJ} pin is taken from a voltage divider referenced to the output voltage. The loop is balanced around the Unity Gain threshold (1.28 V typical).

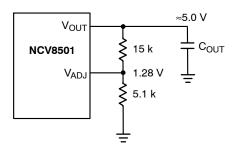


Figure 17. Adjustable Output Voltage

APPLICATION NOTES

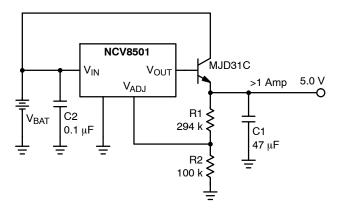


Figure 18. Additional Output Current

Adding Capability

Figure 18 shows how the adjustable version of parts can be used with an external pass transistor for additional current capability. The setup as shown will provide greater than 1 Amp of output current.

FLAG MONITOR

Figure 19 shows the FLAG Monitor waveforms as a result of the circuit depicted in Figure 16. As the output voltage falls (V_{OUT}), the Monitor threshold is crossed. This causes the voltage on the FLAG output to go low sending a warning signal to the microprocessor that a RESET signal may occur in a short period of time. T_{WARNING} is the time the microprocessor has to complete the function it is currently working on and get ready for the RESET shutdown signal.

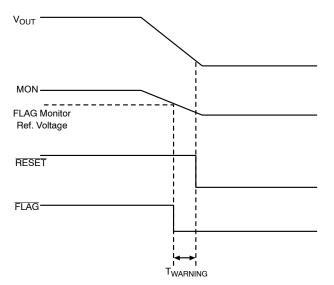
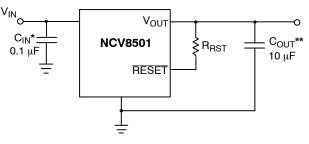


Figure 19. FLAG Monitor Circuit Waveform



*C_{IN} required if regulator is located far from the power supply filter **C_{OUT} required for stability. Capacitor must operate at minimum temperature expected

Figure 20. Test and Application Circuit Showing Output Compensation

SETTING THE DELAY TIME

The delay time is controlled by the Reset Delay Low Voltage, Delay Switching Threshold, and the Delay Charge Current. The delay follows the equation:

$$t_{\text{DELAY}} = \frac{\left[\text{C}_{\text{DELAY}}(V_{\text{dt}} - \text{Reset Delay Low Voltage})\right]}{\text{Delay Charge Current}}$$

Example:

Using $C_{DELAY} = 33$ nF.

Assume reset Delay Low Voltage = 0.

Use the typical value for $V_{dt} = 1.8$ V.

Use the typical value for Delay Charge Current = $2.5 \,\mu$ A.

$$t_{\text{DELAY}} = \frac{\left[33 \text{ nF}(1.8 - 0)\right]}{2.5 \,\mu\text{A}} = 23.8 \text{ ms}$$

STABILITY CONSIDERATIONS

The output or compensation capacitor helps determine three main characteristics of a linear regulator: start–up delay, load transient response and loop stability.

The capacitor value and type should be based on cost, availability, size and temperature constraints.

The value for the output capacitor C_{OUT} shown in Figure 20 should work for most applications, however it is not necessarily the optimized solution.

UNDERSTANDING THE NCV8501 ENABLE PIN INPUT CURRENT

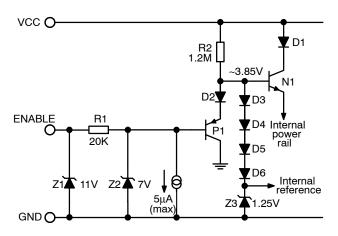


Figure 21. NCV8501 Enable Function Equivalent Circuit

Z1, R1, and Z2 provide ESD and overvoltage protection. Note that, for ENABLE pin voltages in excess of 10 V, an external series resistor is required to limit the current into Z1.

For ENABLE pin voltages less than +7 V, the 5 μ A (maximum value) current source dominates the input current, as the opposing P1 base current is negligible by comparison.

For ENABLE pin voltages between +7 V and +11 V, the input current is given by:

 $5 \,\mu\text{A} + ((V_{\text{ENABLE}} - 7) / 20 \,\text{k}\Omega)$

For ENABLE pin voltages in excess of 10 V (Z1 breakover voltage can be as low as 10 V), the input current is dominated by the external series resistor. For the case where $V_{\text{ENABLE}} = 12$ V; $R_{\text{EXT}} = 10$ kΩ, the input current can be up to (2 V/10 kΩ), = 200 µA.

The ENABLE threshold is that voltage required to achieve ~3.85 V at the base of N1, or approximately (3.85 V – 2 Vbe). At +20°C, this threshold is ~2.55 V. At –40°C, it can be as high as 3 V.

If the value of R_{EXT} is increased to ~200 k Ω , to reduce ENABLE input current, then the worst-case drop across R_{EXT} must be added to 3 V to determine the effective maximum ENABLE threshold. At $V_{ENABLE} < 7$ V, we only need to consider the 5 μ A current sink.

Max effective threshold = $3 V + (5 \mu A * 220 k\Omega)$ = 3 V + 1.1 V= 4.1 V

CALCULATING POWER DISSIPATION IN A SINGLE OUTPUT LINEAR REGULATOR

The maximum power dissipation for a single output regulator (Figure 22) is:

$$P_{D(max)} = [V_{IN(max)} - V_{OUT(min)}]I_{OUT(max)} + V_{IN(max)}I_{Q}$$
(eq. 1)

where:

V_{IN(max)} is the maximum input voltage,

V_{OUT(min)} is the minimum output voltage,

 $I_{OUT(max)}$ is the maximum output current for the application, and

 I_Q is the quiescent current the regulator consumes at $I_{OUT(max)}$.

Once the value of $P_{D(max)}$ is known, the maximum permissible value of $R_{\theta JA}$ can be calculated:

$$R_{\Theta JA} = \frac{150^{\circ}C - T_{A}}{P_{D}} \qquad (eq. 2)$$

The value of $R_{\theta JA}$ can then be compared with those in the package section of the data sheet. Those packages with $R_{\theta JA}$'s less than the calculated value in Equation 2 will keep the die temperature below 150°C.

In some cases, none of the packages will be sufficient to dissipate the heat generated by the IC, and an external heatsink will be required.

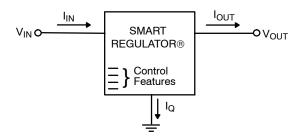


Figure 22. Single Output Regulator with Key Performance Parameters Labeled

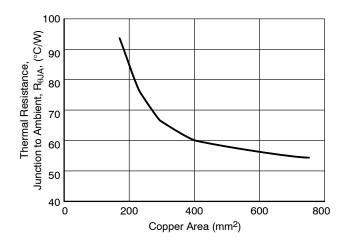


Figure 23. 16 Lead SOW (Exposed Pad), θJA as a Function of the Pad Copper Area (2 oz. Cu Thickness), Board Material = 0.0625" G-10/R-4

HEATSINKS

A heatsink effectively increases the surface area of the package to improve the flow of heat away from the IC and into the surrounding air.

Each material in the heat flow path between the IC and the outside environment will have a thermal resistance. Like series electrical resistances, these resistances are summed to determine the value of $R_{\theta JA}$:

$$R_{\theta JA} = R_{\theta JC} + R_{\theta CS} + R_{\theta SA} \qquad (eq. 3)$$

where:

- $R_{\theta JC}$ = the junction-to-case thermal resistance,
- $R_{\theta CS}$ = the case-to-heatsink thermal resistance, and
- $R_{\theta SA}$ = the heatsink-to-ambient thermal resistance.

 $R_{\theta JC}$ appears in the package section of the data sheet. Like $R_{\theta JA}$, it too is a function of package type. $R_{\theta CS}$ and $R_{\theta SA}$ are functions of the package type, heatsink and the interface between them. These values appear in heatsink data sheets of heatsink manufacturers.

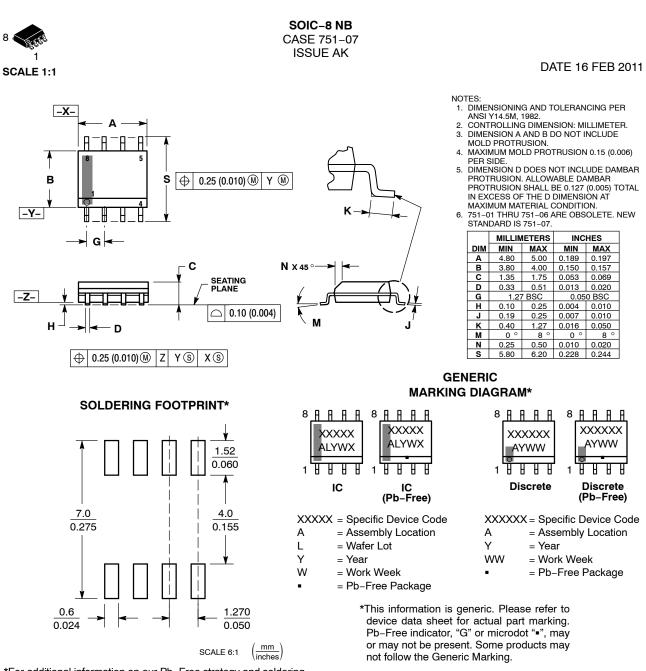
ORDERING INFORMATION

Device	Output Voltage	Package	Shipping†
NCV8501DADJG	Adjustable	SO-8 (Pb-Free)	98 Units/Rail
NCV8501DADJR2G	Adjustable	SO-8 (Pb-Free)	2500 Tape & Reel
NCV8501PDWADJG	Adjustable	SOW-16 Exposed Pad (Pb-Free)	47 Units/Rail
NCV8501PDWADJR2G	Adjustable	SOW-16 Exposed Pad (Pb-Free)	1000 Tape & Reel
NCV8501D25G	2.5 V	SO-8 (Pb-Free)	98 Units/Rail
NCV8501D25R2G	2.5 V	SO-8 (Pb-Free)	2500 Tape & Reel
NCV8501PDW25G	2.5 V	SOW-16 Exposed Pad (Pb-Free)	47 Units/Rail
NCV8501PDW25R2G	2.5 V	SOW-16 Exposed Pad (Pb-Free)	1000 Tape & Reel
NCV8501D33G	3.3 V	SO-8 (Pb-Free)	98 Units/Rail
NCV8501D33R2G	3.3 V	SO-8 (Pb-Free)	2500 Tape & Reel
NCV8501PDW33G	3.3 V	SOW-16 Exposed Pad (Pb-Free)	47 Units/Rail
NCV8501PDW33R2G	3.3 V	SOW-16 Exposed Pad (Pb-Free)	1000 Tape & Reel
NCV8501D50G	5.0 V	SO-8 (Pb-Free)	98 Units/Rail
NCV8501D50R2G	5.0 V	SO-8 (Pb-Free)	2500 Tape & Reel
NCV8501PDW50G	5.0 V	SOW-16 Exposed Pad (Pb-Free)	47 Units/Rail
NCV8501PDW50R2G	5.0 V	SOW-16 Exposed Pad (Pb-Free)	1000 Tape & Reel
NCV8501D80G	8.0 V	SO-8 (Pb-Free)	98 Units/Rail
NCV8501D80R2G	8.0 V	SO-8 (Pb-Free)	2500 Tape & Reel
NCV8501PDW80G	8.0 V	SOW-16 Exposed Pad (Pb-Free)	47 Units/Rail
NCV8501PDW80R2G	8.0 V	SOW-16 Exposed Pad (Pb-Free)	1000 Tape & Reel
NCV8501D100G	10 V	SO-8 (Pb-free)	98 Units/Rail
NCV8501D100R2G	10 V	SO-8 (Pb-Free)	2500 Tape & Reel
NCV8501PDW100G	10 V	SOW-16 Exposed Pad (Pb-Free)	47 Units/Rail
NCV8501PDW100R2G	10 V	SOW-16 Exposed Pad (Pb-Free)	1000 Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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SOIC-8 NB CASE 751-07 **ISSUE AK**

STYLE 1: PIN 1. EMITTER COLLECTOR 2. COLLECTOR 3. 4. EMITTER EMITTER 5. BASE 6. 7 BASE EMITTER 8. STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN DRAIN 4. GATE 5. 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6 BASE. DIE #2 BASE, DIE #1 7. 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3 GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. DRAIN 8. STYLE 17: PIN 1. VCC 2. V2OUT V10UT З. TXE 4. 5. RXE 6. VFF 7. GND 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3 CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. 8. CATHODE 6 STYLE 25: PIN 1. VIN 2 N/C REXT З. 4. GND 5. IOUT 6. IOUT IOUT 7. 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. 2 EMITTER, #1 BASE, #2 З. EMITTER, #2 4. 5 COLLECTOR, #2 COLLECTOR, #2 6.

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 3. 4 COLLECTOR, #2 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: GROUND PIN 1. BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND 6. BIAS 2 INPUT 7. 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3 P-SOURCE P-GATE 4. P-DRAIN 5 6. P-DRAIN N-DRAIN 7. N-DRAIN 8. STYLE 18: PIN 1. ANODE ANODE 2. SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. CATHODE 8. STYLE 22: PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3 COMMON CATHODE/VCC 4. I/O LINE 3 5. COMMON ANODE/GND 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND STYLE 26: PIN 1. GND 2 dv/dt З. ENABLE 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8. VCC STYLE 30: DRAIN 1 PIN 1. DRAIN 1 2 GATE 2 З. SOURCE 2 4. SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5.

6.

7.

8 GATE 1

SOURCE 1/DRAIN 2

STYLE 3: PIN 1. DRAIN, DIE #1 DRAIN, #1 2. DRAIN, #2 З. 4. DRAIN, #2 GATE, #2 5. SOURCE, #2 6. 7 GATE #1 8. SOURCE, #1 STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS THIRD STAGE SOURCE GROUND З. 4. 5. DRAIN 6. GATE 3 SECOND STAGE Vd 7. FIRST STAGE Vd 8. STYLE 11: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. З. GATE 2 4. 5. DRAIN 2 6. DRAIN 2 DRAIN 1 7. 8. DRAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 ANODE 1 3 ANODE 1 4. 5. CATHODE, COMMON CATHODE, COMMON CATHODE, COMMON 6. 7. CATHODE, COMMON 8. STYLE 19: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. **MIRROR 1** STYLE 23: PIN 1. LINE 1 IN COMMON ANODE/GND COMMON ANODE/GND 2. 3 LINE 2 IN 4. LINE 2 OUT 5. COMMON ANODE/GND COMMON ANODE/GND 6. 7. LINE 1 OUT 8. STYLE 27: PIN 1. ILIMIT OVI O 2 UVLO З. 4. INPUT+ 5. 6. SOURCE SOURCE SOURCE 7. 8 DRAIN

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STYLE 4: PIN 1. 2. ANODE ANODE ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 BASE #2 З. COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE SOURCE 2. 3. GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 16: PIN 1. EMITTER, DIE #1 2. BASE, DIE #1 EMITTER, DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE EMITTER 2. 3 COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE 6. CATHODE COLLECTOR/ANODE 7. 8. COLLECTOR/ANODE STYLE 28: PIN 1. SW_TO_GND 2. DASIC OFF DASIC_SW_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK 8 VIN

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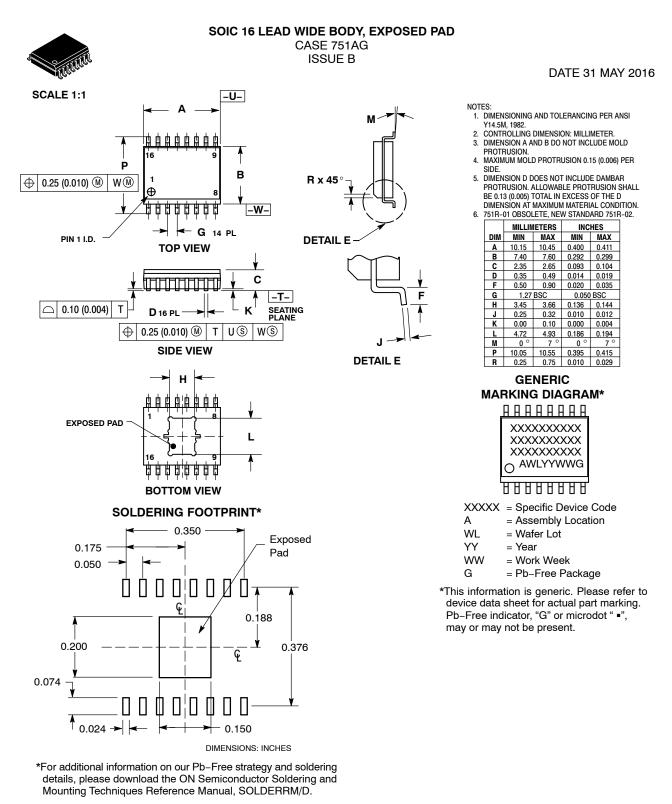
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COLLECTOR, #1

COLLECTOR, #1





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